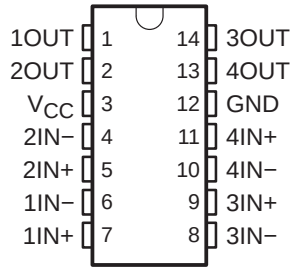
- **Single Supply or Dual Supplies**
- **Wide Range of Supply Voltage . . . 2 V to 28 V**
- **Low Supply-Current Drain Independent of Supply Voltage . . . 0.8 mA Typ**
- **Low Input Bias Current . . . 25 nA Typ**
- **Low Input Offset Current . . . 3 nA Typ**
- **Low Input Offset Voltage . . . 3 mV Typ**
- **Common-Mode Input Voltage Range Includes Ground**
- **Differential Input Voltage Range Equal to Maximum-Rated Supply Voltage . . . ±28 V**
- **Low Output Saturation Voltage**
- **Output Compatible With TTL, MOS, and CMOS**

D OR N PACKAGE
(TOP VIEW)



description/ordering information

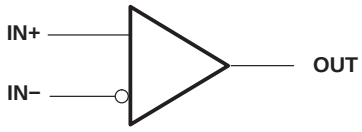
This device consists of four independent voltage comparators that are designed to operate from a single power supply over a wide range of voltages. Operation from dual supplies also is possible as long as the difference between the two supplies is 2 V to 28 V and V_{CC} is a least 1.5 V more positive than the input common-mode voltage. Current drain is independent of the supply voltage. The outputs can be connected to other open-collector outputs to achieve wired-AND relationships.

ORDERING INFORMATION

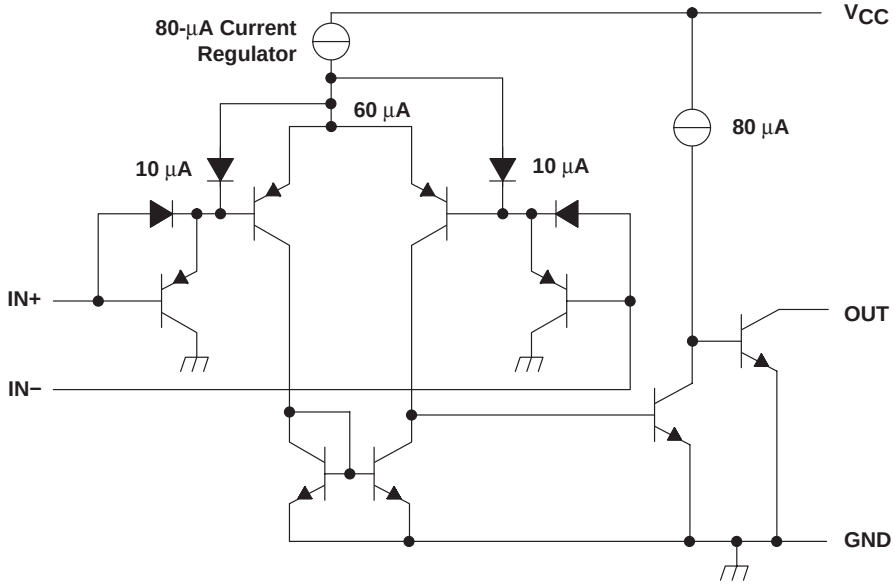
T_A	V_{IO}max AT 25°C	PACKAGE†		ORDERABLE PART NUMBER	TOP-SIDE MARKING
−40°C to 85°C	20 mV	PDIP (N)	Tube of 25	LM3302N	LM3302N
		SOIC (D)	Tube of 50	LM3302D	LM3302
			Reel of 2500	LM3302DR	

† Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.

symbol (each comparator)



schematic



Current values shown are nominal.

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage, V_{CC} (see Note 1) . . . . . 28 V
Differential input voltage, V_{ID} (see Note 2) . . . . . ±28 V
Input voltage range, V_I (either input) . . . . . −0.3 V to 28 V
Output voltage, V_O . . . . . 28 V
Output current, I_O . . . . . 20 mA
Duration of output short-circuit to ground (see Note 3) . . . . . Unlimited
Package thermal impedance, θ_{JA} (see Notes 4 and 5): D package . . . . . 86°C/W
N package . . . . . 80°C/W
Operating virtual junction temperature, T_J . . . . . 150°C
Lead temperature 1,6 mm (1/16 inch) from case for 10 seconds: D or N package . . . . . 260°C
Storage temperature range, T_{stg} . . . . . −65°C to 150°C

† Stresses beyond those listed under absolute maximum ratings may cause permanent damage to the device. There are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the recommended operating conditions section of this specification is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES:
1. All voltage values, except differential voltages, are with respect to the network ground.
2. Differential voltages are at IN+ with respect to IN−.
3. Short circuits from the output to V_{CC} can cause excessive heating and eventual destruction.
4. Maximum power dissipation is a function of $T_J(max)$, θ_{JA}, and T_A. The maximum allowable power dissipation at any allowable ambient temperature is $P_D = (T_J(max) - T_A)/\theta_{JA}$. Operating at the absolute maximum T_J of 150°C can affect reliability.
5. The package thermal impedance is calculated in accordance with JESD 51-7.

electrical characteristics at specified free-air temperature, V_{CC} = 5 V (unless otherwise noted)

PARAMETER		TEST CONDITIONS†		T_A	MIN	TYP	MAX	UNIT
V_{IO}	Input offset voltage	V_{CC} = 5 V to 28 V, V_O = 1.4 V	$V_{IC} = V_{ICR}$min,	25°C		3	20	mV
				−40°C to 85°C			40	
I_{IO}	Input offset voltage	V_O = 1.4 V		25°C		3	100	nA
				−40°C to 85°C			300	
I_{IB}	Input bias current			25°C		−25	−500	nA
				−40°C to 85°C			−1000	
V_{ICR}	Common-mode input voltage range			25°C	0 to V_{CC}−1.5			V
				−40°C to 85°C	0 to V_{CC}−2			
A_{VD}	Large-signal differential voltage amplification	V_{CC} = 15 V, R_L = 15 Ω to V_{CC}	V_O = 1.4 V to 11.4 V,	25°C	2	30		V/mV
I_{OH}	High-level output current	V_{ID} = 1 V,	V_{OH} = 5 V	25°C		0.1		nA
				−40°C to 85°C			1	µA
V_{OL}	Low-level output voltage	V_{ID} = −1 V,	I_{OL} = 4 mA	25°C		150	500	mV
				−40°C to 85°C			700	
I_{OL}	Low-level output current	V_{ID} = 1 V,	V_{OL} = 1.5 V	25°C	6	16		mA
I_{CC}	Supply current (four comparators)	V_O = 2.5 V,	No load	25°C		0.8		mA

† All characteristics are measured with zero common-mode input voltage unless otherwise specified.

switching characteristics, V_{CC} = 5 V, T_A = 25°C

PARAMETER	TEST CONDITIONS				TYP	UNIT
Response time	R_L = 5.1 kΩ to 5 V,	C_L = 15 pF‡,	See Note 6	100-mV input step with 5-mV overdrive	1.3	µs
				TTL-level input step	0.3	

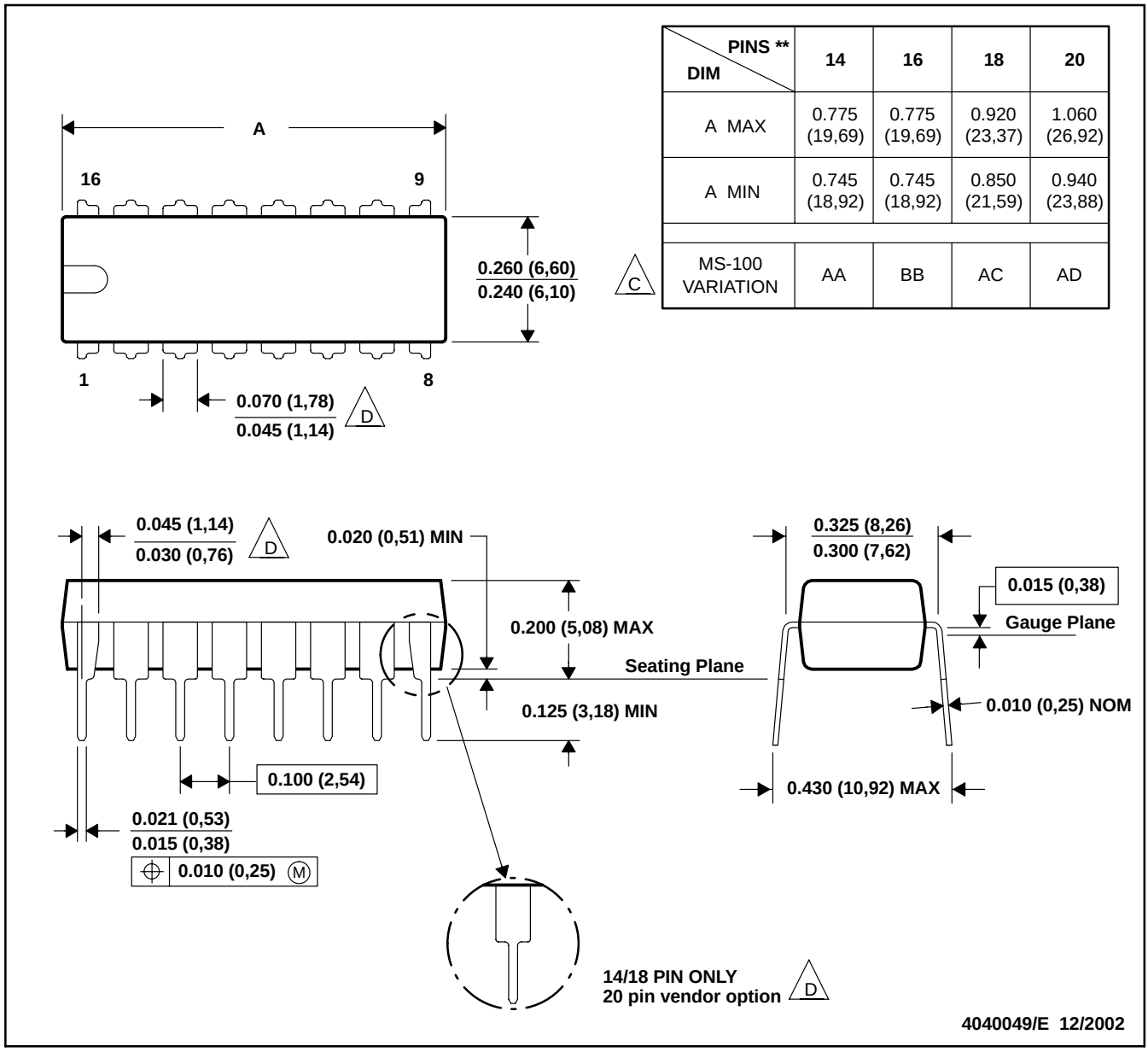
‡ C_L includes probe and jig capacitance.

NOTE 6: The response time specified is the interval between the input step function and the instant when the output crosses 1.4 V.

N (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



DIM \ PINS **	14	16	18	20
A MAX	0.775 (19,69)	0.775 (19,69)	0.920 (23,37)	1.060 (26,92)
A MIN	0.745 (18,92)	0.745 (18,92)	0.850 (21,59)	0.940 (23,88)
MS-100 VARIATION	AA	BB	AC	AD

NOTES: A. All linear dimensions are in inches (millimeters).

B. This drawing is subject to change without notice.

C. Falls within JEDEC MS-001, except 18 and 20 pin minimum body lrngth (Dim A).

D. The 20 pin end lead shoulder width is a vendor option, either half or full width.

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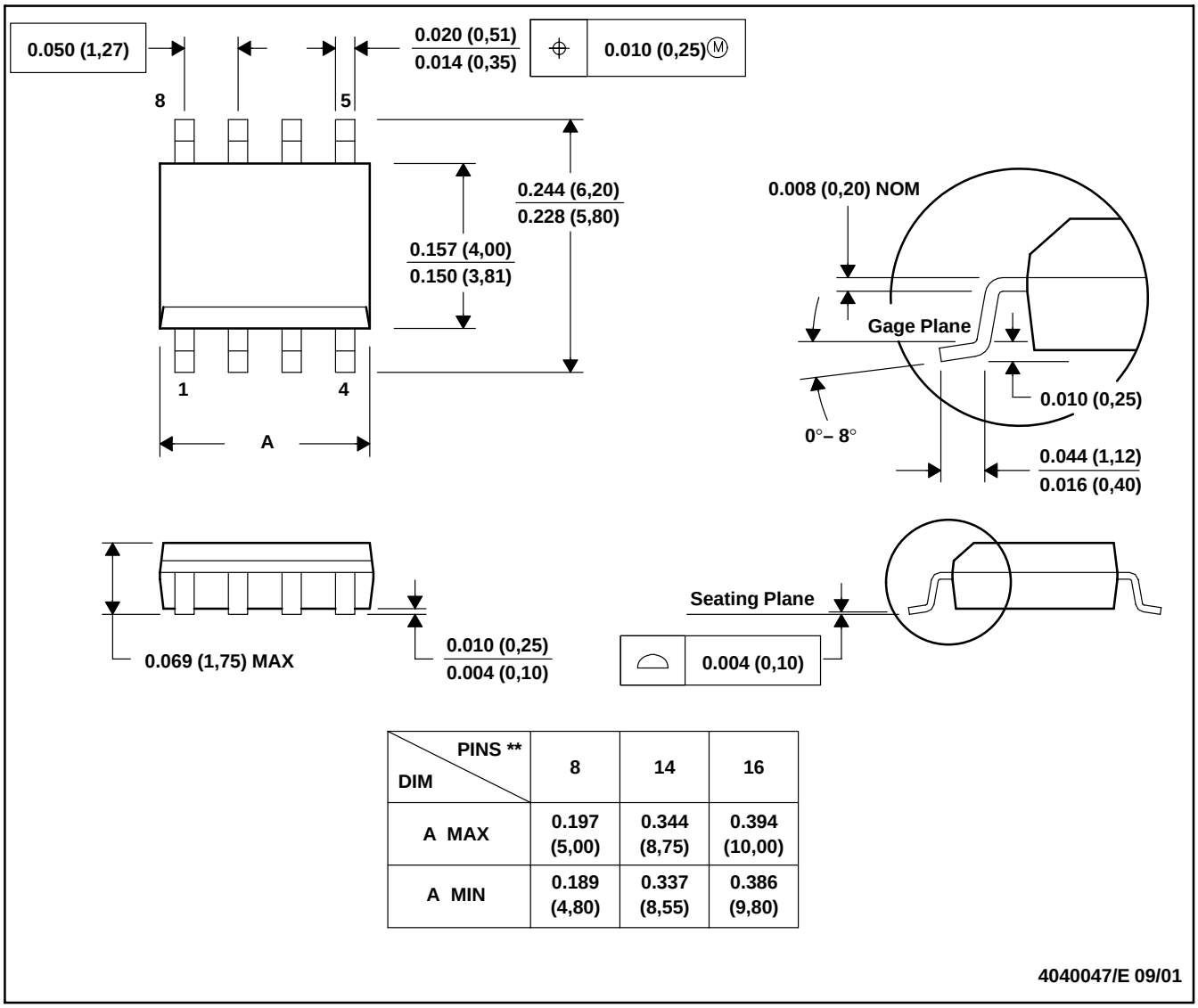
D (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE

8 PINS SHOWN



DIM \ PINS **	8	14	16
A MAX	0.197 (5,00)	0.344 (8,75)	0.394 (10,00)
A MIN	0.189 (4,80)	0.337 (8,55)	0.386 (9,80)

4040047/E 09/01

NOTES: A. All linear dimensions are in inches (millimeters).
B. This drawing is subject to change without notice.
C. Body dimensions do not include mold flash or protrusion, not to exceed 0.006 (0,15).
D. Falls within JEDEC MS-012

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